

MOS FIELD EFFECT TRANSISTOR 2SK3062

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- · Low on-state resistance
 - $R_{\text{DS(on)1}}$ = 8.5 m Ω MAX. (Vgs = 10 V, Ip = 35 A)
 - $R_{DS(on)2} = 12 \text{ m}\Omega$ MAX. (Vgs = 4.0 V, ID = 35 A)
- Low Ciss: Ciss = 5200 pF TYP.
- Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3062	TO-220AB
2SK3062-S	TO-262
2SK3062-ZJ	TO-263

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vss = 0 V)	Voss	60	V
Gate to Source Voltage (Vps = 0 V)	VGSS(AC)	±20	V
Gate to Source Voltage (Vps = 0 V)	VGSS(DC)	+20, -10	V
Drain Current (DC)	ID(DC)	±70	Α
Drain Current (Pulse) Note1	D(pulse)	±280	Α
Total Power Dissipation (Tc = 25°C)	PT	100	W
Total Power Dissipation (T _A = 25°C)	PT	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	IAS	35	Α
Single Avalanche Energy Note2	Eas	122.5	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

2. Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0 V

THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.25	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

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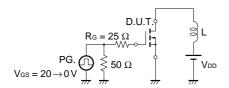
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

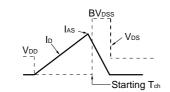


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

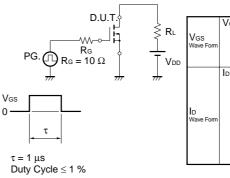
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	V _G S = 10 V, I _D = 35 A		6.3	8.5	mΩ
	RDS(on)2	Vgs = 4.0 V, ID = 35 A		8.2	12	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0	1.5	2.0	٧
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 35 A	20	87		S
Drain Leakage Current	IDSS	V _{DS} = 60 V, V _{GS} = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V		5200		pF
Output Capacitance	Coss	V _G S = 0 V		1300		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		480		pF
Turn-on Delay Time	td(on)	ID = 35 A		75		ns
Rise Time	tr	V _{GS(on)} = 10 V		1150		ns
Turn-off Delay Time	t _{d(off)}	VDD = 30 V		360		ns
Fall Time	t _f	$R_G = 10 \Omega$		480		ns
Total Gate Charge	QG	ID = 70 A		95		nC
Gate to Source Charge	Qgs	V _{DD} = 48 V		13		nC
Gate to Drain Charge	Q _{GD}	V _{GS(on)} = 10 V		30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 70 A, VGS = 0 V		0.97		V
Reverse Recovery Time	trr	IF = 70 A, VGS = 0 V		70		ns
Reverse Recovery Charge	Qrr	$di/dt = 100 A/\mu s$		140		nC

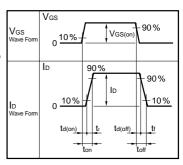
TEST CIRCUIT 1 AVALANCHE CAPABILITY





TEST CIRCUIT 2 SWITCHING TIME

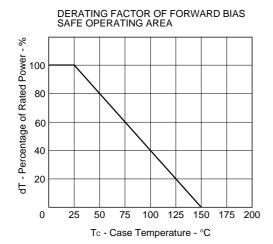


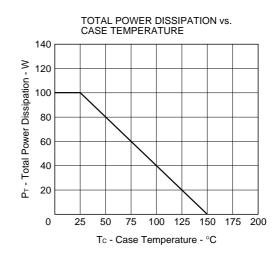


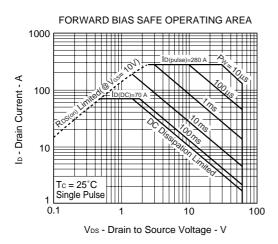
TEST CIRCUIT 3 GATE CHARGE

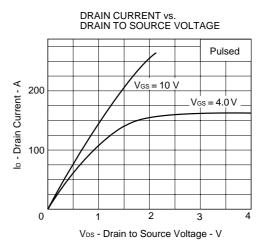


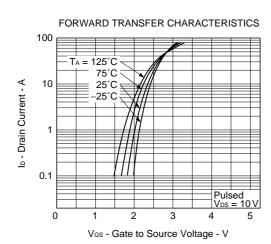
TYPICAL CHARACTERISTICS (TA = 25 °C)





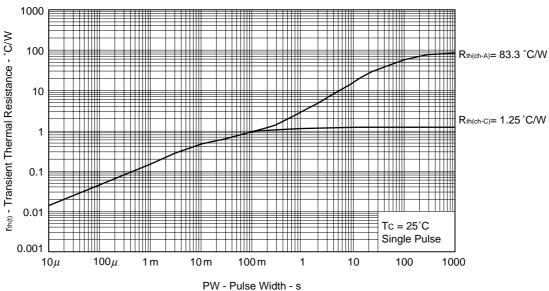




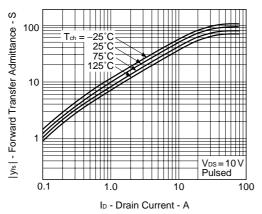


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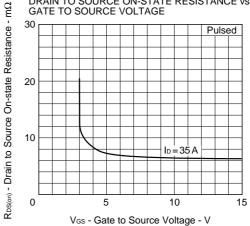
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

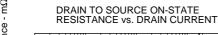


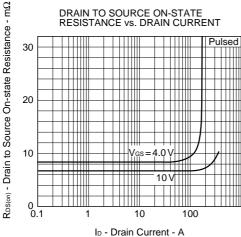


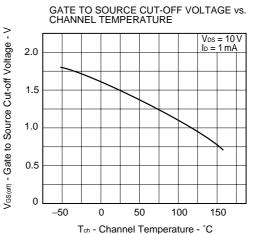


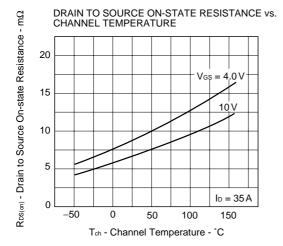
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

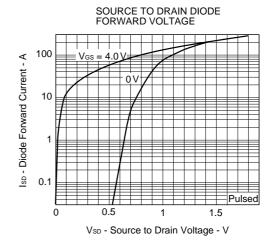


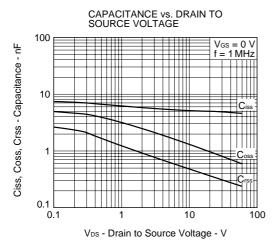


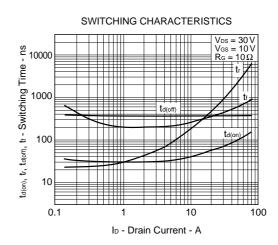


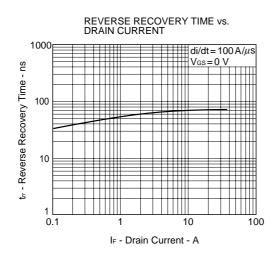


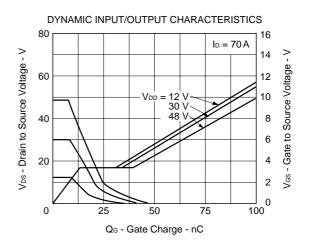


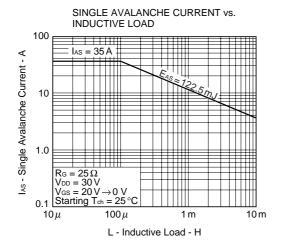


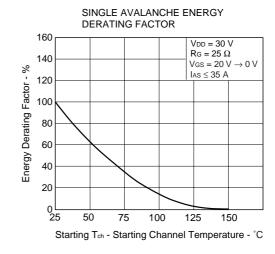








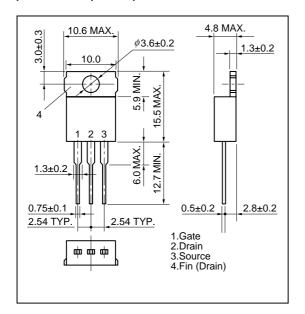




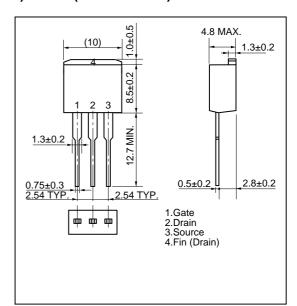


PACKAGE DRAWINGS (Unit: mm)

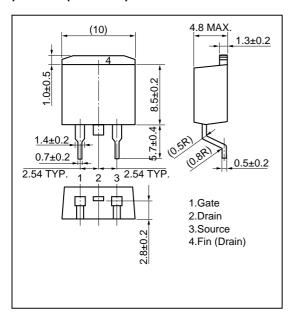
1)TO-220AB (MP-25)



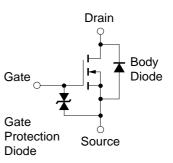
2)TO-262 (MP-25 Fin Cut)



3)TO-263 (MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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